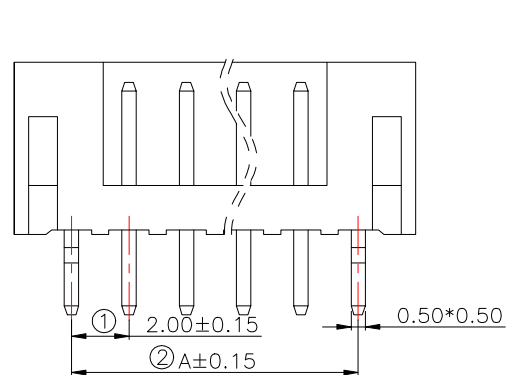


SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

技术要求:

1. 塑件材料: PA66(UL-94V-0)
2. 接触件: 黄铜镀锡
3. 接触电阻: $\leq 10\text{m}\Omega$
4. 绝缘电阻: $\geq 100\text{M}\Omega$
5. 额定电压: 250V AC DC
6. 额定电流: 2.0A AC DC
7. 耐压: 能承受 1000V AC/Minute
8. 工作温度: $-25^{\circ}\sim+85^{\circ}$
9. 可焊性试验: 浸锡面积 $\geq 95\%$ 温度 $235 \pm 5^{\circ}$, 时间 2.5 ± 0.5 秒
10. 铅和镉等六大有害物质含量要符合环保要求。

Part No	Pin	A	B
WAFER-PH2.0-2PZZ	2	2.00	6.00
WAFER-PH2.0-3PZZ	3	4.00	8.00
WAFER-PH2.0-4PZZ	4	6.00	10.00
WAFER-PH2.0-5PZZ	5	8.00	12.00
WAFER-PH2.0-6PZZ	6	10.00	14.00
WAFER-PH2.0-7PZZ	7	12.00	16.00
WAFER-PH2.0-8PZZ	8	14.00	18.00
WAFER-PH2.0-9PZZ	9	16.00	20.00
WAFER-PH2.0-10PZZ	10	18.00	22.00
WAFER-PH2.0-11PZZ	11	20.00	24.00
WAFER-PH2.0-12PZZ	12	22.00	26.00
WAFER-PH2.0-13PZZ	13	24.00	28.00
WAFER-PH2.0-14PZZ	14	26.00	30.00
WAFER-PH2.0-15PZZ	15	28.00	32.00
WAFER-PH2.0-16PZZ	16	30.00	34.00
WAFER-PH2.0-17PZZ	17	32.00	36.00
WAFER-PH2.0-18PZZ	18	34.00	38.00
WAFER-PH2.0-19PZZ	19	36.00	40.00
WAFER-PH2.0-20PZZ	20	38.00	42.00

2	端子Contact	黄铜	N*1	电镀(锡): 整个表面镀底镍 30u"MIN, 再镀锡80u"MIN
1	基座Wafer	PA66(UL94 V-0)	1	白色
序号	名称	材料	数量	备注
MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co., Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES		 TITLE: WAFER PH2.0MM 直针		
DECIMALS:		PAR		
.X±0.20		DWN		
.XX±0.10		CHKD		
.XXX±0.05		APVD		
ANGLES:		SCALE 1:1		
±2°		UNIT:MM		
		SIZE:A4		
		SHEET:1F1		
		REV:A		
		CUSTOMER COPY		